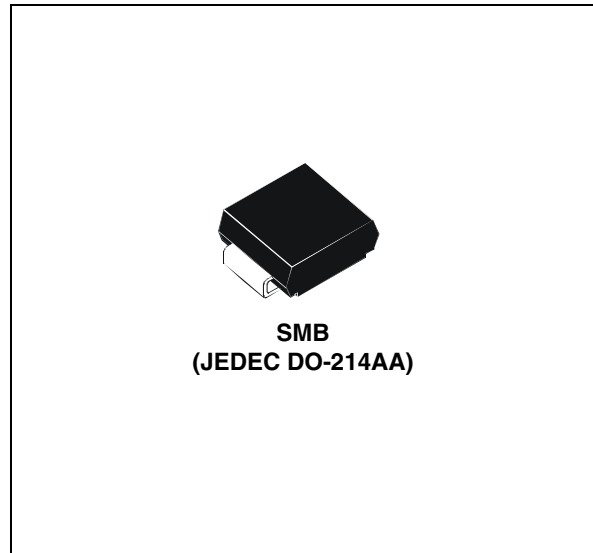


Features

- Bidirectional crowbar protection
- Repetitive peak pulse current (T_{amb} -40 °C to +85 °C)
 - $I_{PP} = 100$ A (10/1000 μ s)
 - $I_{PP} = 200$ A (5/310 μ s)
 - $I_{PP} = 500$ A (2/10 μ s)
- Breakdown voltage: from 72 V to 310 V
- Operating T_j max: 150 °C
- Micro capacitance technology
- JEDEC registered package outline

Complies with the following standards

- Telcordia GR-1089
- ITU-T K20/21/45 enhanced level
- TIA-968
- YD/T 950 / 993 / 1082
- IEC 61000-4-5
- IEC 61000-4-2 level 4
 - ± 15 kV (air discharge)
 - ± 8 kV (contact discharge)
- MIL STD 883H - Method 3015-8 Class 3B
- Resin meets UL 94, V0
- MIL-STD-750, method 2026 solderability
- EIA STD RS-481 and IEC 60286-3 packing
- IPC 7531 footprint
- UL497B recognized, UL file E136224



Description

The devices in the SMP-0SCMC series are micro capacitance Trisils designed to protect broadband telecommunication equipment such as DSL modems, subscriber gateways and DSLAMs from lightning surges and power faults.

Trisils are not subject to aging and provide a failsafe mode in short circuit for a better protection. They are used to help equipment to meet main standards such as UL60950, IEC950 / CSA C22.2 and UL1459.

The SMP-0SCMC series is packaged in SMB.

TM: Trisil is a trademark of STMicroelectronics

1 Characteristics

Table 1. Absolute ratings ($-40\text{ °C} < T_{\text{amb}} < 85\text{ °C}$) for repetitive peak pulse current I_{PP}

Voltage pulse	0.5/700	2/10	1.2/50	10/160	10/560	9/720	10/360	10/1000	10/700	μs
Current pulse	0.2/310	2/10	8/20	10/160	10/560	5/320	10/360	10/1000	5/310	μs
I_{PP}	100	500	400	200	150	200	175	100	200	A

Table 2. Absolute ratings ($T_{\text{amb}} = 25\text{ °C}$) for other parameters

Symbol	Parameter	Value	Unit	
I_{TSM}	Non repetitive surge peak on-state current (sinusoidal) ⁽¹⁾	$t = 10\text{ ms}$	61	A
		$t = 0.2\text{ s}$	18	
		$t = 1\text{ s}$	9	
		$t = 2\text{ s}$	7	
		$t = 15\text{ mn}$	4	
T_{stg}	Storage temperature range	-55 to 150	$^{\circ}\text{C}$	
T_{j}	Operating junction temperature range	-40 to 150	$^{\circ}\text{C}$	
T_{L}	Maximum lead temperature for soldering during 10 s.	260	$^{\circ}\text{C}$	

1. In fail safe mode, the device acts as a short circuit.

Figure 1. Electrical characteristics - definitions ($T_{\text{amb}} = 25\text{ °C}$)

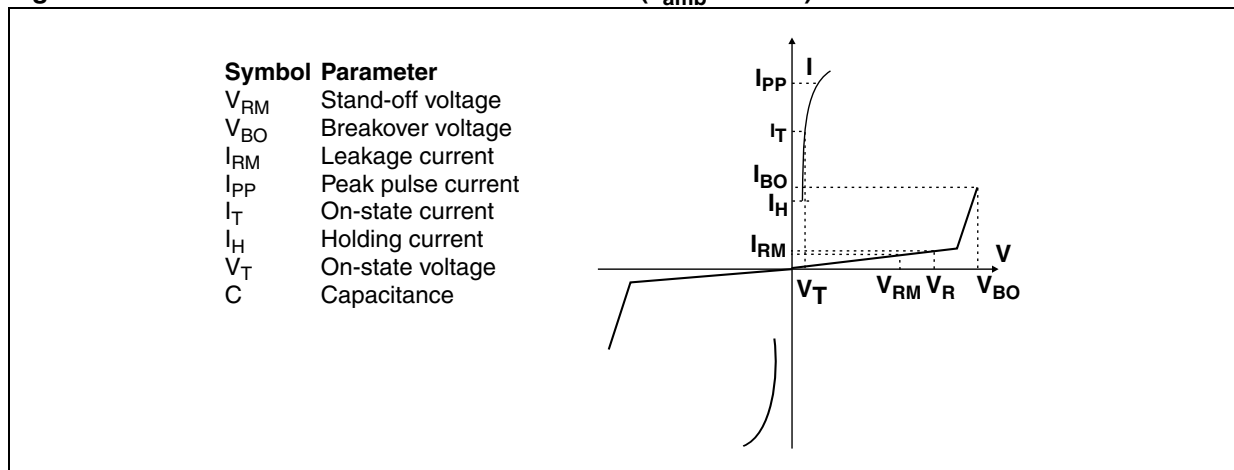


Table 3. Electrical characteristics - values ($T_{amb} = 25\text{ }^{\circ}\text{C}$)

Order code	$I_{RM} \text{ max @ } V_{RM}$		V_{BR}	V_{BO}	I_H	$V_T @ 2.2 \text{ A}$	$C @ 2 \text{ V}$	$C @ 50 \text{ V}$	$\alpha T^{(1)}$
	Max.		Typ.	Max.	Min.	Max.	Max.	Max.	
	μA	V	V	V	mA	V	pF	pF	$10^{-4}/^{\circ}\text{C}$
SMP0720SCMC	5	65	72	88	150	3	80	45	9
SMP0900SCMC	5	75	90	98	150	3	80	45	9.1
SMP1100SCMC	5	90	110	130	150	3	75	40	9.3
SMP1300SCMC	5	120	130	160	150	3	75	40	9.5
SMP1500SCMC	5	140	150	180	150	3	75	40	9.7
SMP1800SCMC	5	170	180	220	150	3	70	35	9.9
SMP2100SCMC	5	180	210	240	150	3	45	25	10.2
SMP2300SCMC	5	190	230	260	150	3	45	25	10.3
SMP2600SCMC	5	220	260	300	150	3	40	20	10.6
SMP3100SCMC	5	275	310	350	150	3	40	20	11

1. For V_{BR} versus junction temperature, use the following formula: $V_{BR} @ T_J = V_{BR} @ 25\text{ }^{\circ}\text{C} \times (1 + \alpha T \times (T_J - 25))$

Figure 2. Pulse waveform

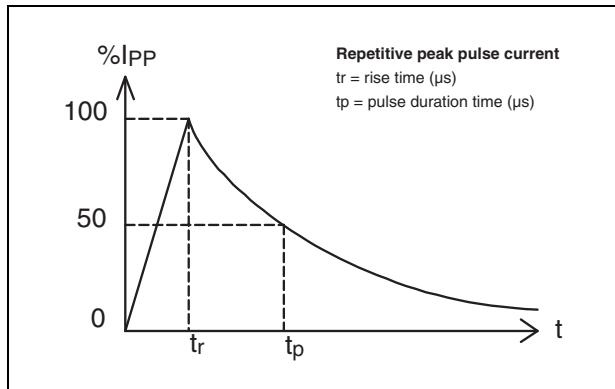


Figure 3. Non repetitive surge peak on-state current versus overload duration

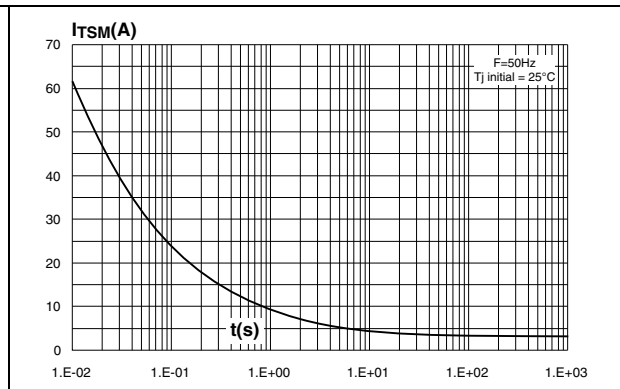


Figure 4. Relative variation of holding current versus junction temperature

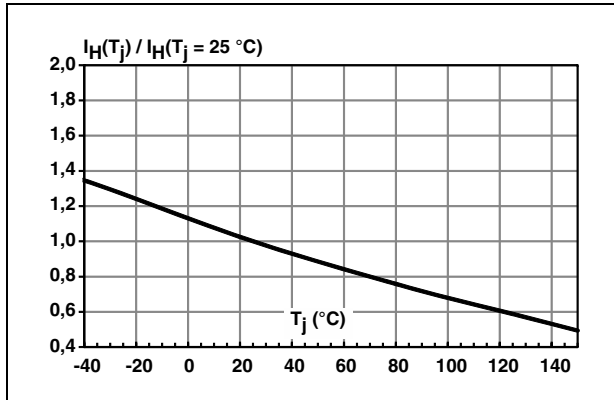


Figure 5. Percentage of change of break over voltage versus junction temperature

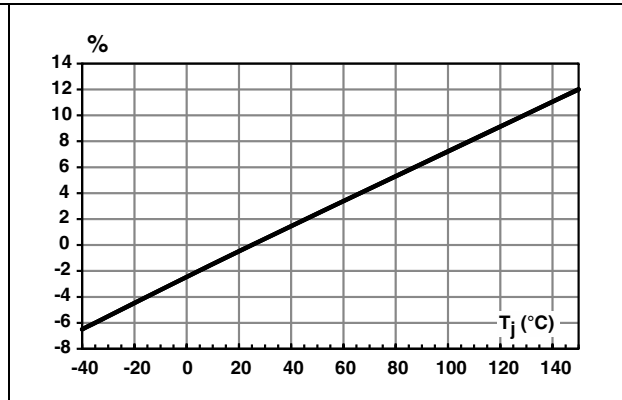
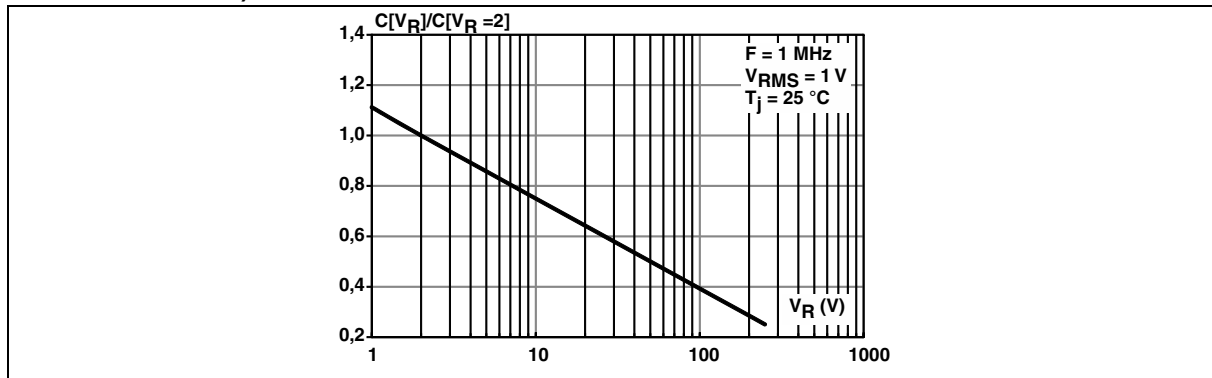


Figure 6. Relative variation of junction capacitance versus reverse applied voltage (typical values)



2 Package information

- Epoxy meets UL94, V0
- Lead-free package

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com. ECOPACK® is an ST trademark.

Table 4. SMB dimensions

Ref.	Dimensions			
	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A1	1.90	2.45	0.075	0.096
A2	0.05	0.20	0.002	0.008
b	1.95	2.20	0.077	0.087
c	0.15	0.40	0.006	0.016
E	5.10	5.60	0.201	0.220
E1	4.05	4.60	0.159	0.181
D	3.30	3.95	0.130	0.156
L	0.75	1.50	0.030	0.059

Figure 7. Footprint dimensions in mm (inches)

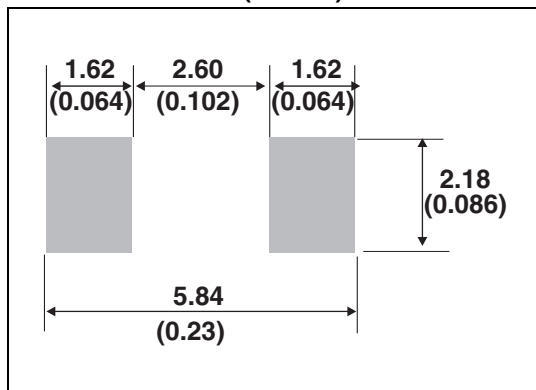
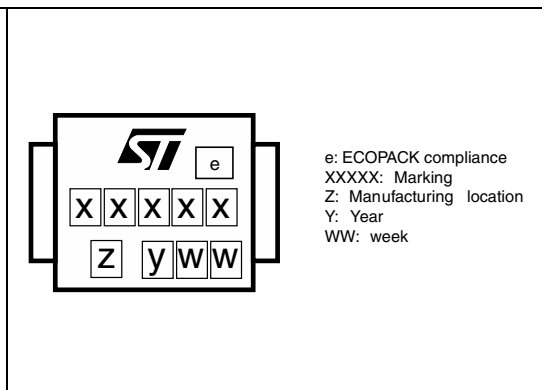


Figure 8. Marking layout



3 Ordering information

Table 5. Ordering information

Order code	Marking	Package	Weight	Base qty	Delivery mode
SMP0720SCMC	P07CM	SMB	98 mg	2500	Tape and reel
SMP0900SCMC	P09CM				
SMP1100SCMC	P11CM				
SMP1300SCMC	P13CM				
SMP1500SCMC	P15CM				
SMP1800SCMC	P18CM				
SMP2100SCMC	P21CM				
SMP2300SCMC	P23CM				
SMP2600SCMC	P26CM				
SMP3100SCMC	P31CM				

4 Revision history

Table 6. Document revision history

Date	Revision	Changes
17-Jan-2013	1	Initial version.

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